

# Analyzing radiation induced defects in GaN MESFETs and JFETs using AC transconductance method

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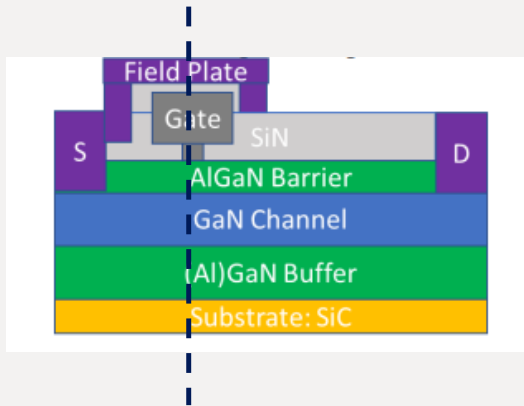
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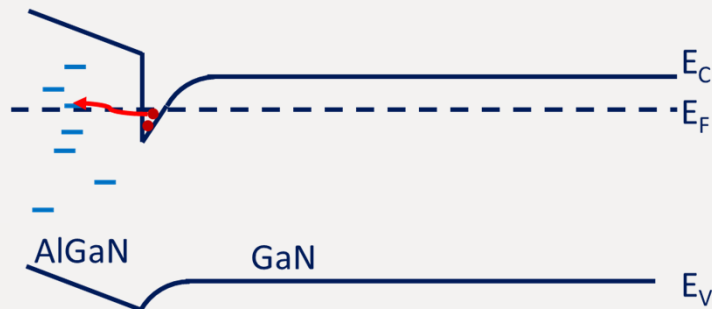
# Year 2 accomplishments

- Revising AC transconductance method for
  - GaN MESFET
  - GaN JFET
- Pre-rad and post-rad characterization of GaN MESFET and JFET using
  - AC transconductance method
  - Low frequency  $1/f$  noise

# AC transconductance method - conventional

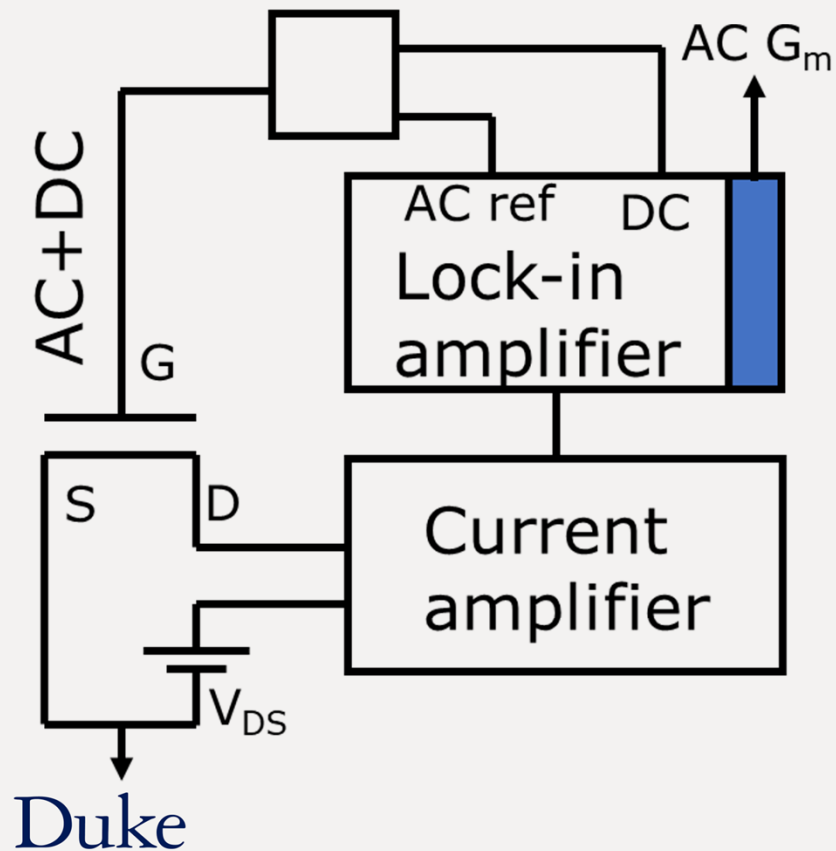


- Proposed by **TP Ma (Sun et al, IEDM 2012)**
- Frequency dispersion of ac  $G_m$  reflects variation of carrier density in the channel
  - Due to capture/emission of carrier in "oxide" traps
- For an AC signal on the gate ( $\delta V_g$ ) with frequency  $\omega$ , the traps with time constant  $\tau$  higher than  $1/\omega$  are not likely to respond



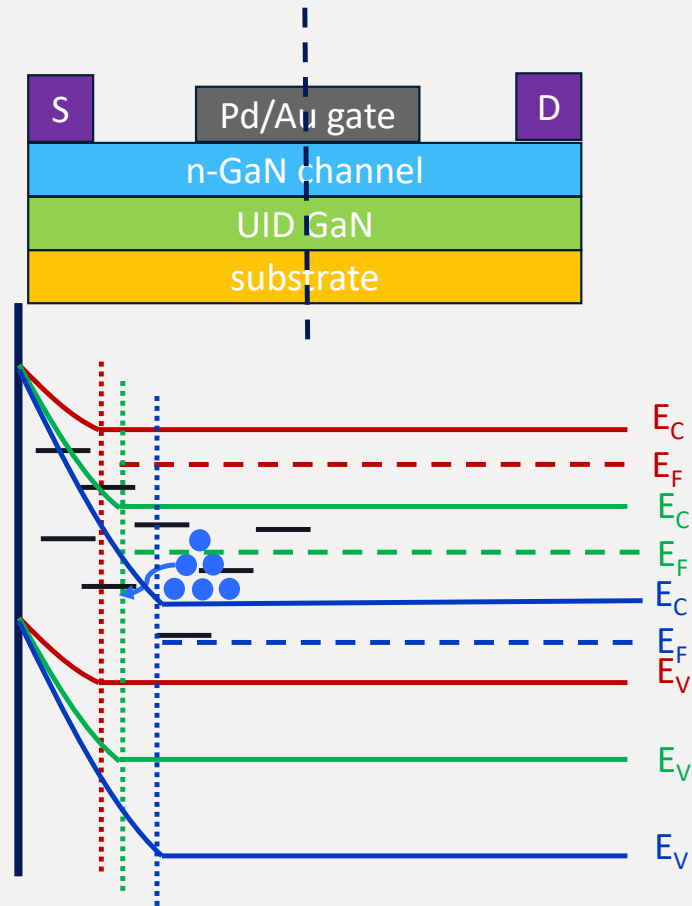
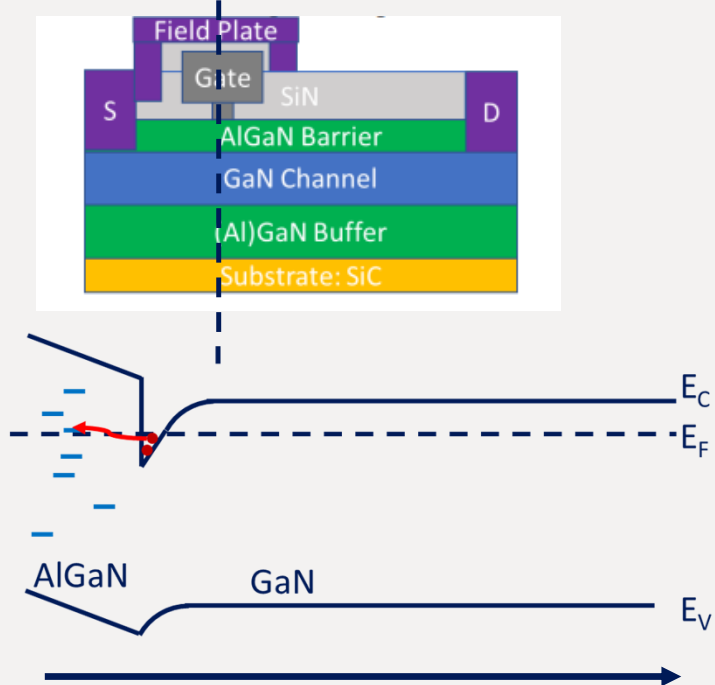
- As  $\omega$  decreases, traps with relatively long  $\tau$  start responding and cause a change in AC  $G_m$
- Trap time constant is determined by both  $E_T$  and  $x$
- Thus, ac gm method gives trap profile both in energy and space

# Experimental setup



$$AC G_m = \frac{\text{Lock-in output current}}{\text{AC peak-to-peak voltage}}$$

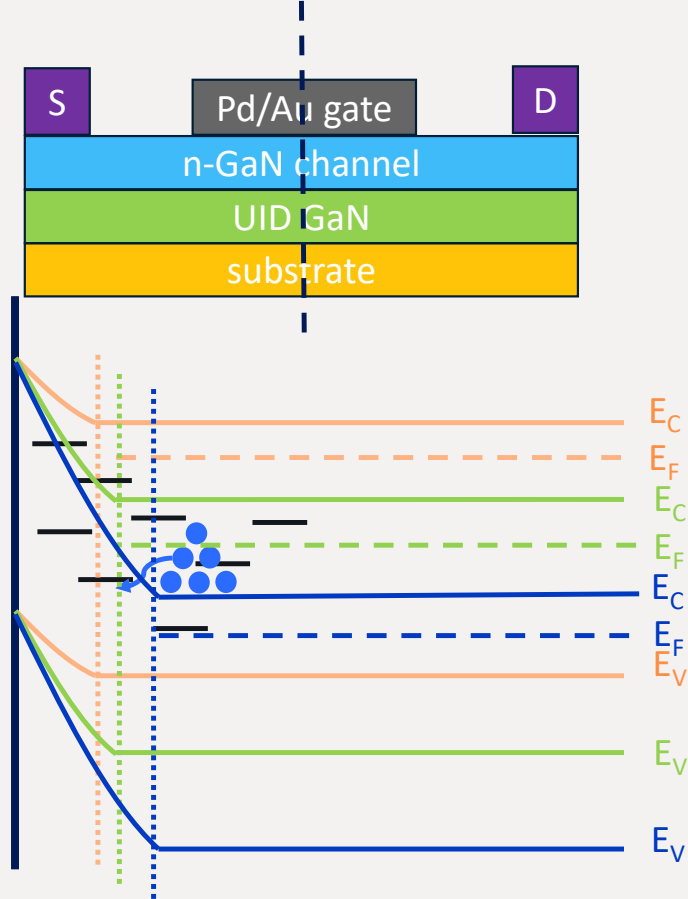
# Comparing HEMT with MESFET for AC-Gm



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A new model needs to be developed for AC transconductance on MESFETs

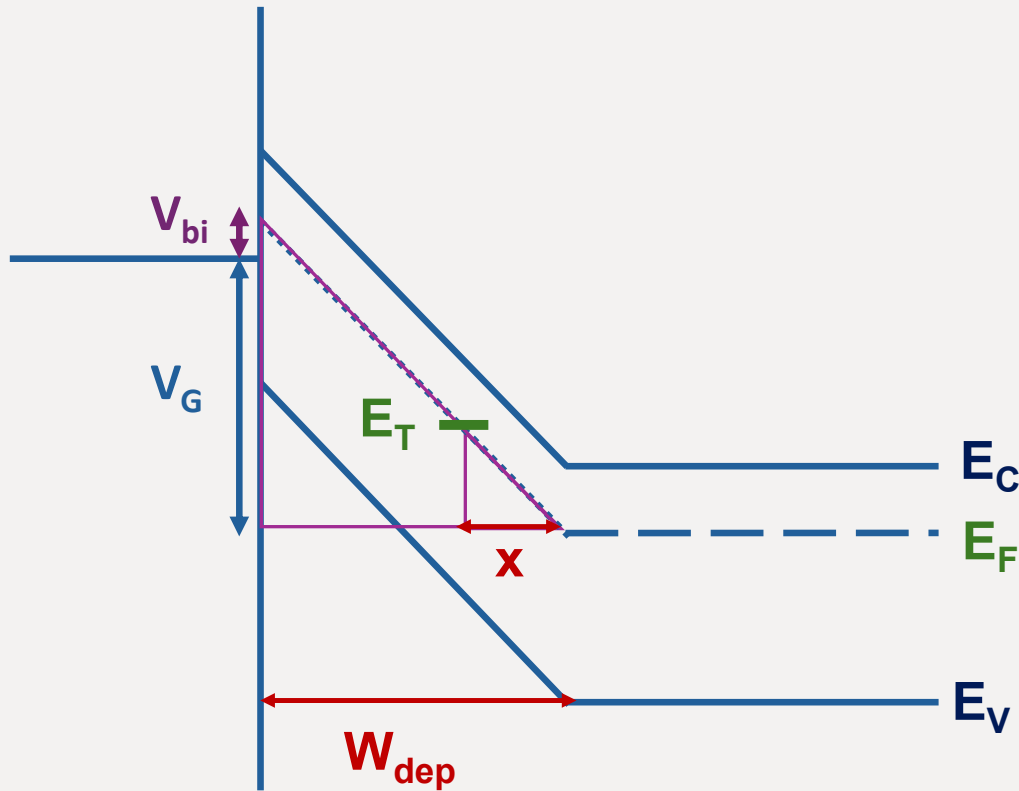
# AC transconductance on MESFET - modified



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- ✓ Frequency dispersion of ac  $G_m$  reflects variation of carrier density in the channel
  - Due to capture/emission of carrier in depletion region
  - But, depletion width and channel position varies with  $V_G$ !
- ✓ For an AC signal on the gate ( $\delta V_g$ ) with frequency  $\omega$ , the traps with time constant  $\tau$  higher than  $1/\omega$  are not likely to respond
- ✓ As  $\omega$  decreases, traps with relatively long  $\tau$  start responding and cause a change in AC  $G_m$

# AC transconductance on MESFET-modified



$$E_T - E_F = (V_G + V_{bi}) \frac{x}{W_{dep}}$$

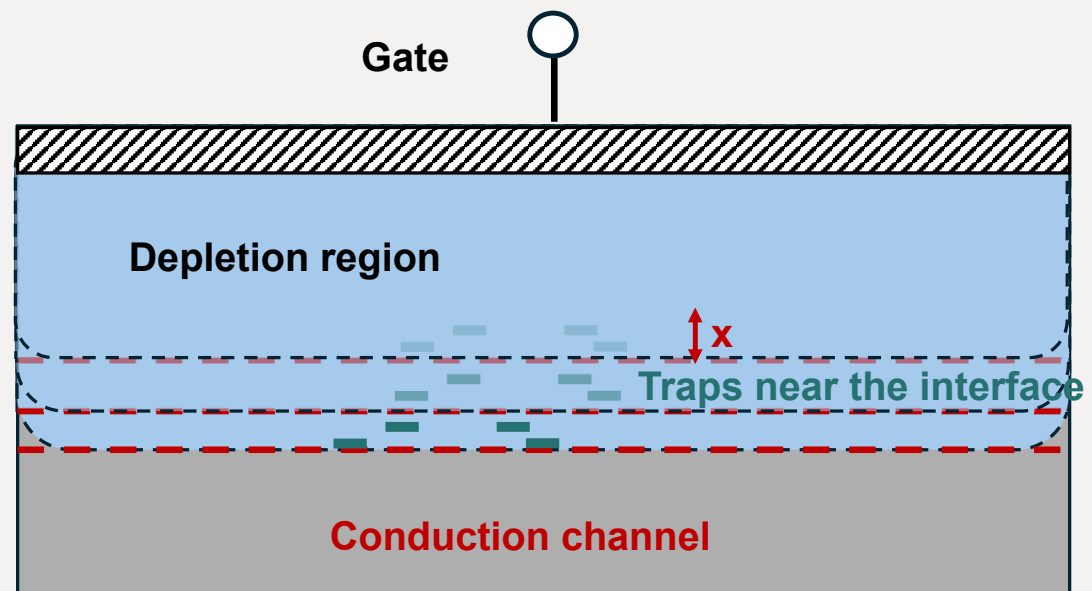
# AC transconductance on MESFET

- Trap density:

$$N_T(E_T, x) = \frac{dG_m}{d \ln(\omega)} \left[ \left( 1 - \frac{x(VG)}{W_{dep}(VG)} \right) \left( \frac{x(VG)}{W_{dep}(VG)} \right) q \lambda V_{ds} \mu_{dc} \frac{W W_{dep}(VG)}{aL} \left( \frac{1}{\sqrt{1 - \frac{V_{GS} - V_T}{V_{p0}}}} \right) \right]^{-1}$$

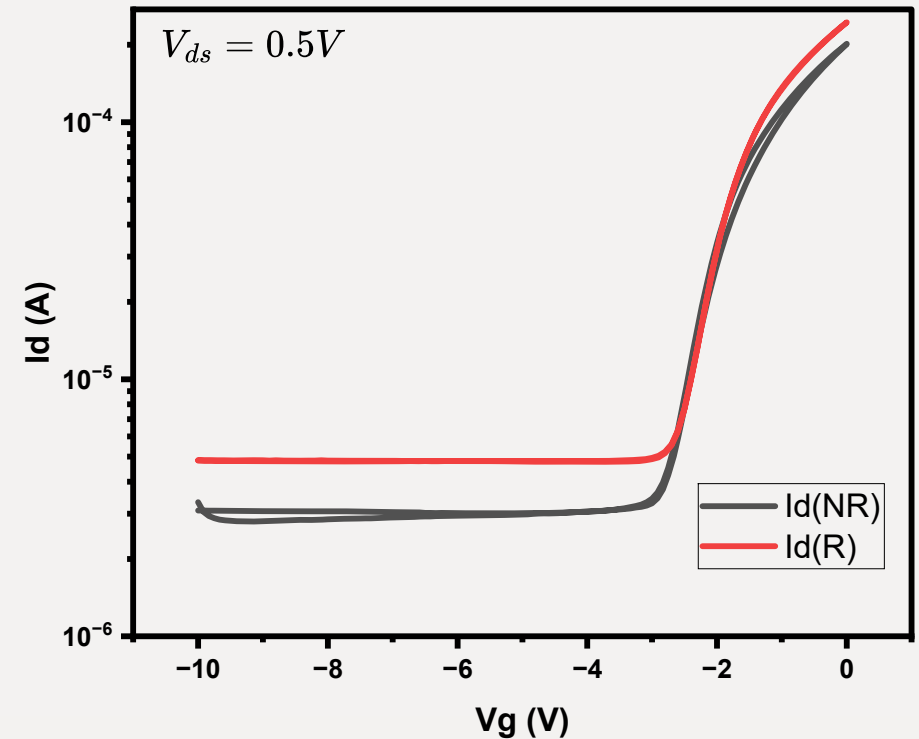
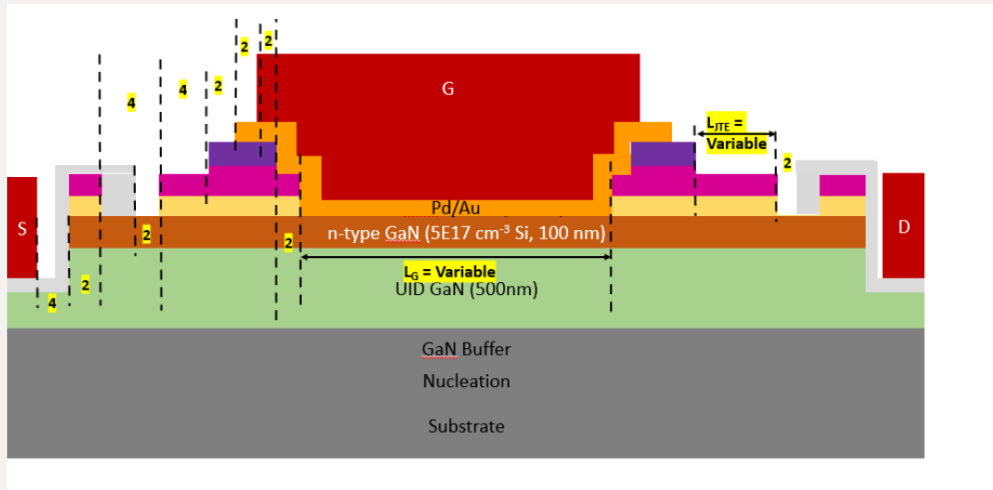
- Probing depth:

$$x = \lambda \ln \left( \frac{1}{\omega \tau_0} \right)$$





# MESFET device characteristics

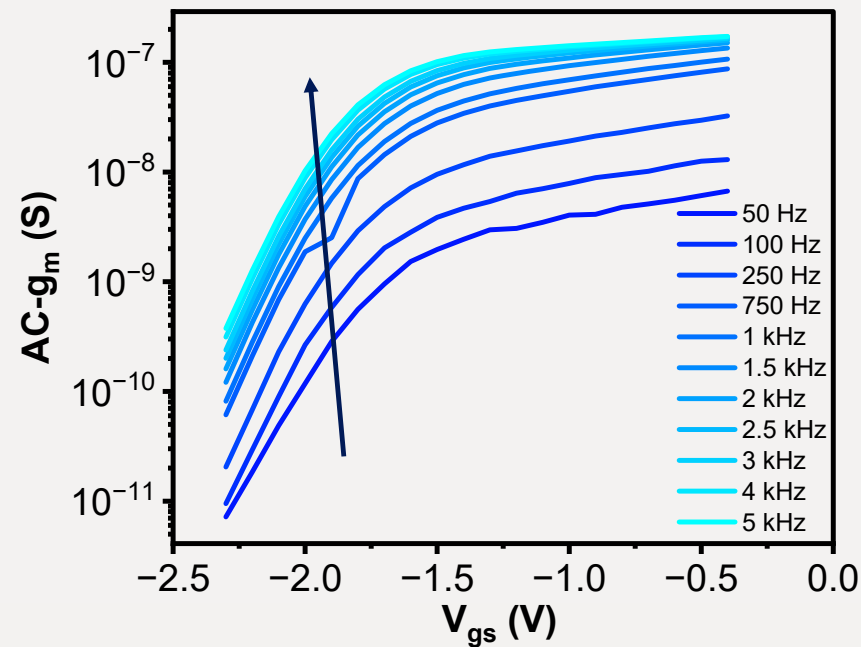


- Radiation condition:  $10^7$  cm<sup>-2</sup> Au ion
  - Gate leakage increase after irradiation
- \*\*Devices from Chu group, Penn State

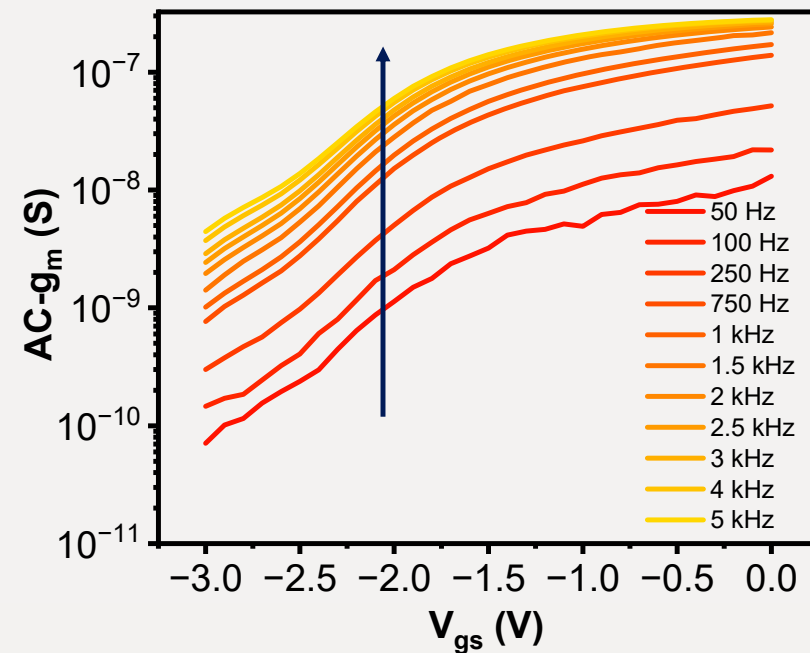
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# MESFET: Dispersion in ac transconductance

before radiation

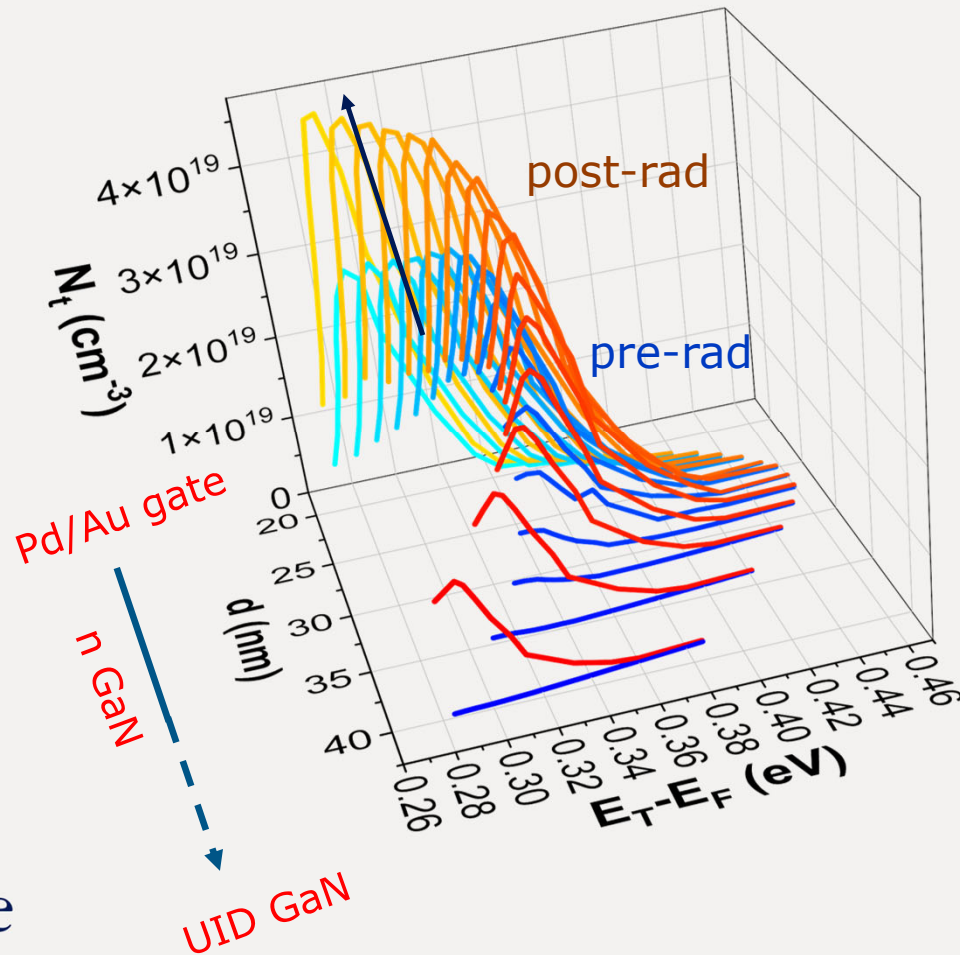
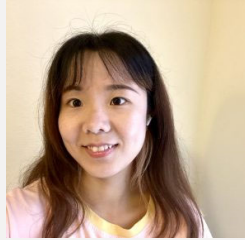


after irradiation



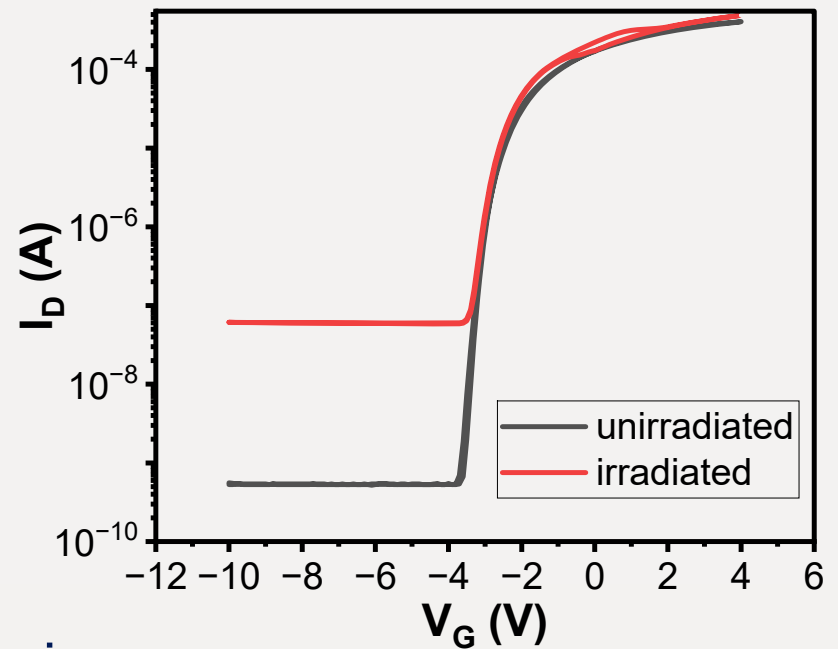
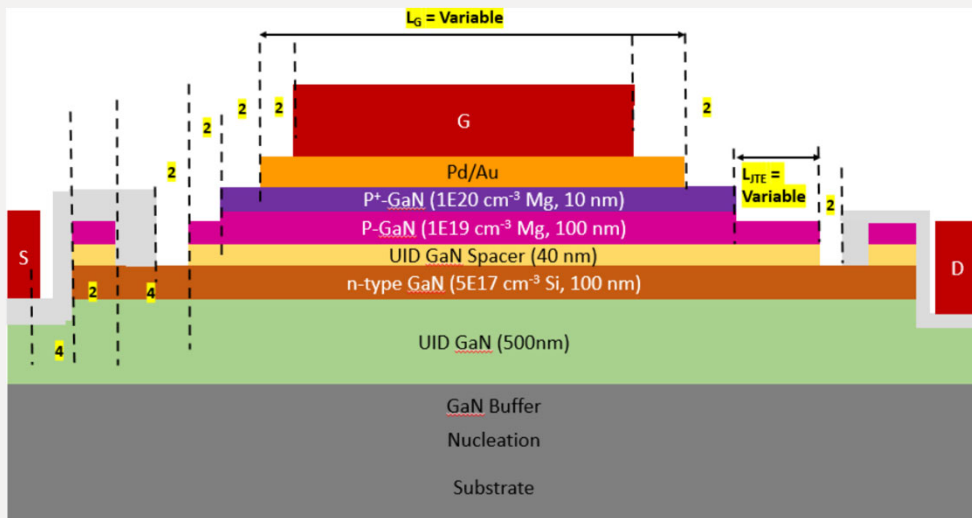
- AC transconductance decreases with decreasing frequency
- Traps with longer time constants respond to the lower frequencies
  - Capture electrons

# Trap distribution in energy and space



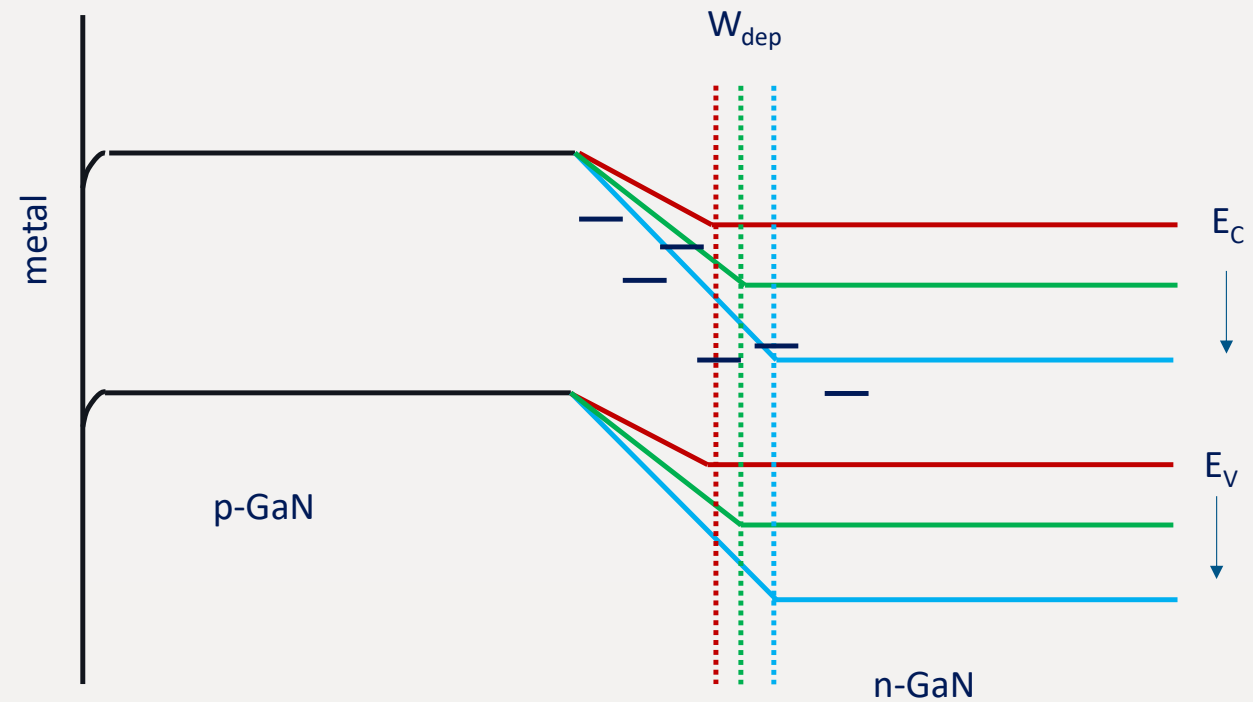
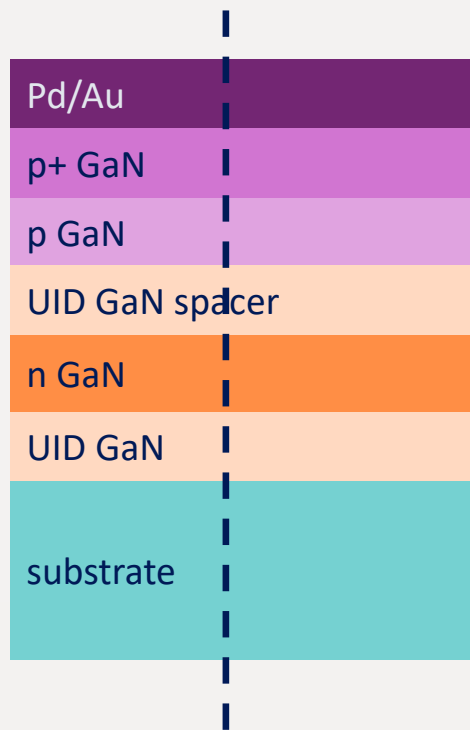
- Trap density in n-GaN depletion region increases after irradiation
- Consistent with increase in leakage after irradiation
- Further modifications:
  - $E_T - E_F$  can be converted to  $E_C - E_T$  using TCAD simulations
  - Instead of electron capture through tunneling, other mechanisms of capture?

# JFET characteristics



- Radiation:  $10^7$  cm<sup>-2</sup> Au ions
- Increase in gate leakage

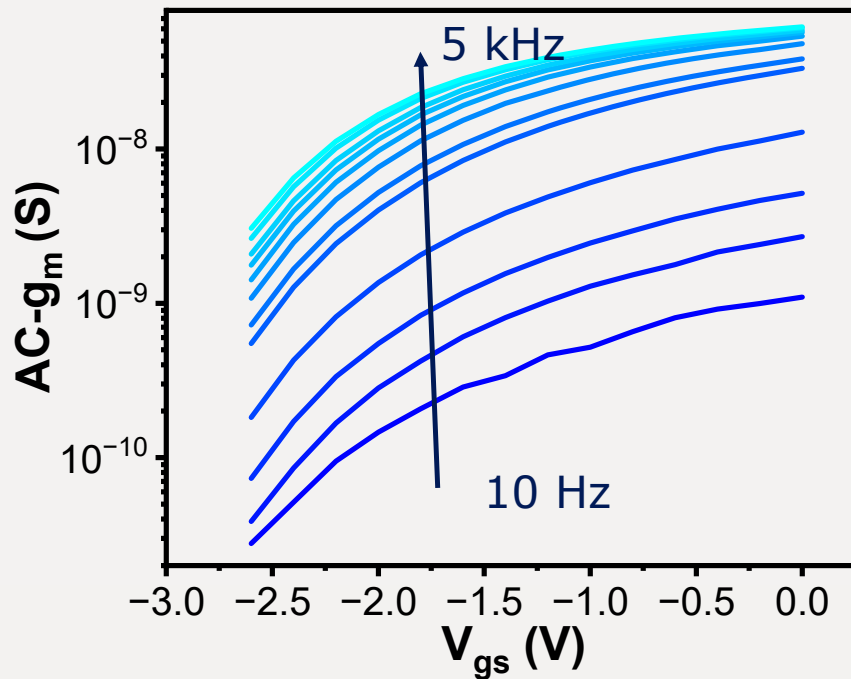
# AC transconductance measurement method for JFET



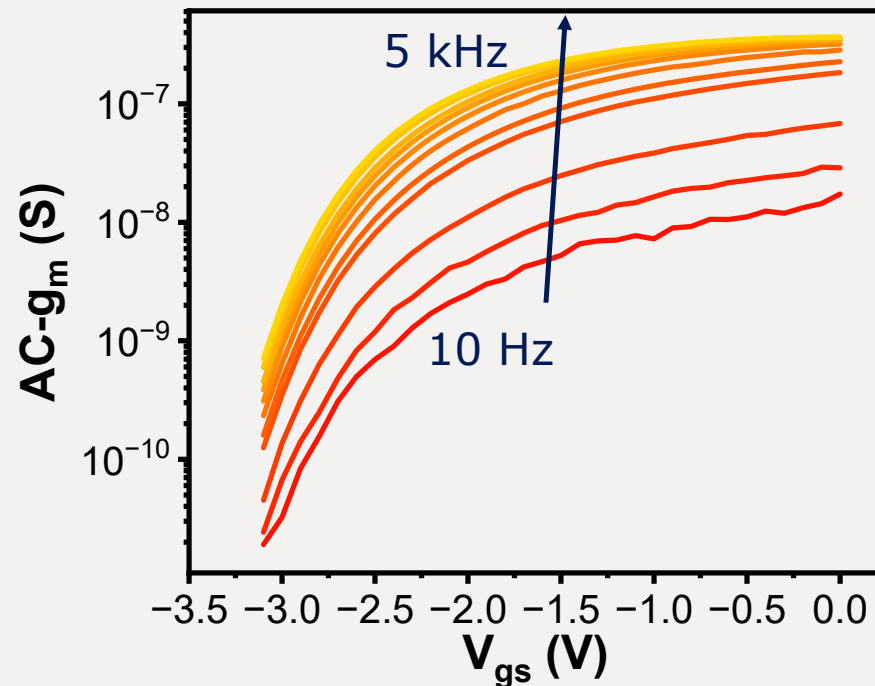
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# JFET: Dispersion in ac transconductance

before radiation



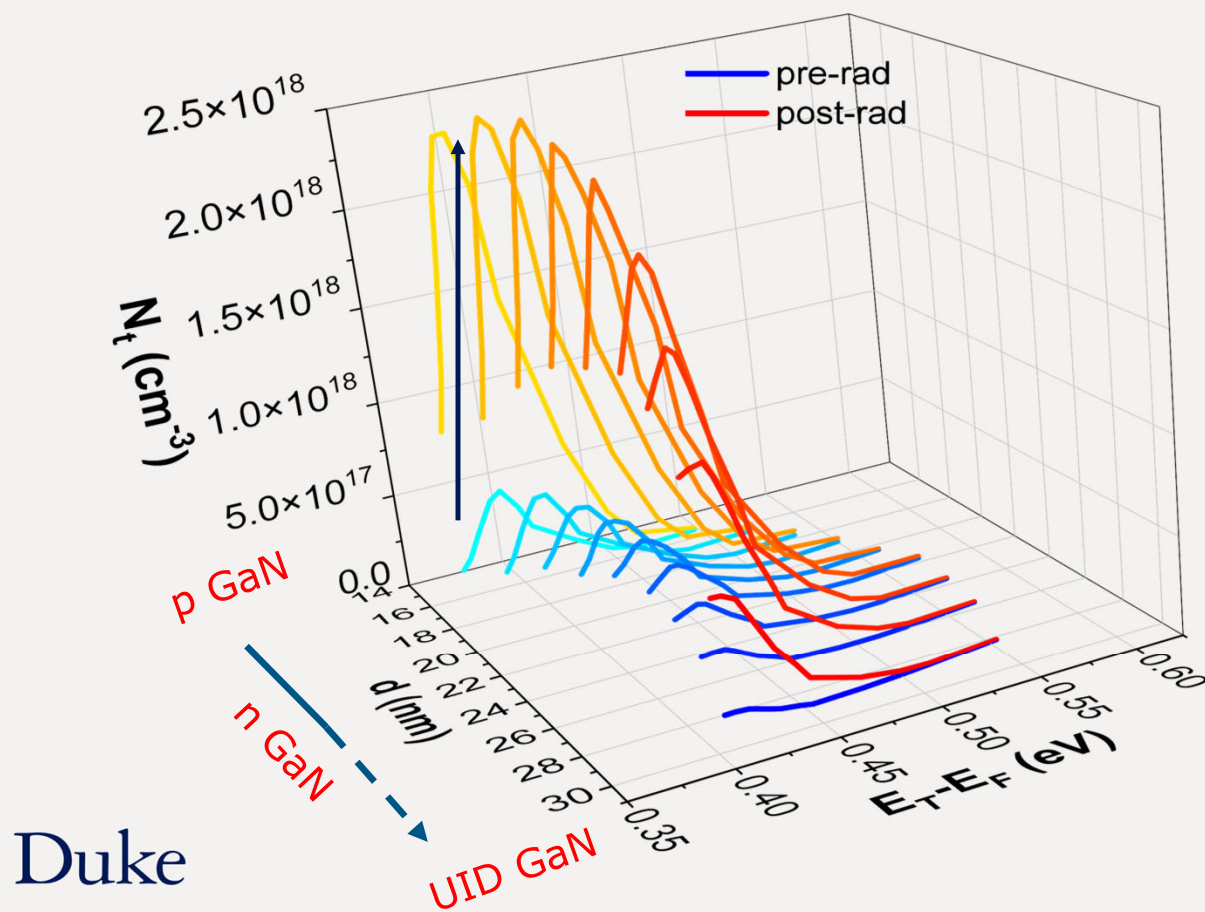
after irradiation



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- AC transconductance decreases with decreasing frequency
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# Trap distribution in energy and space



- Increase in trap density in n-GaN depletion region after irradiation

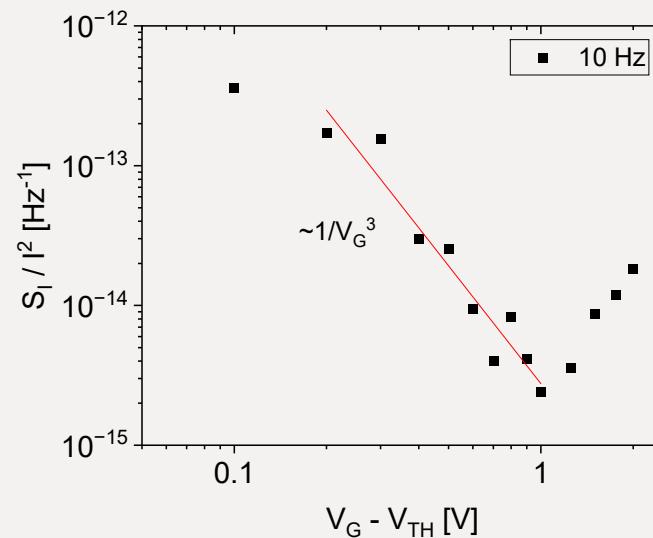
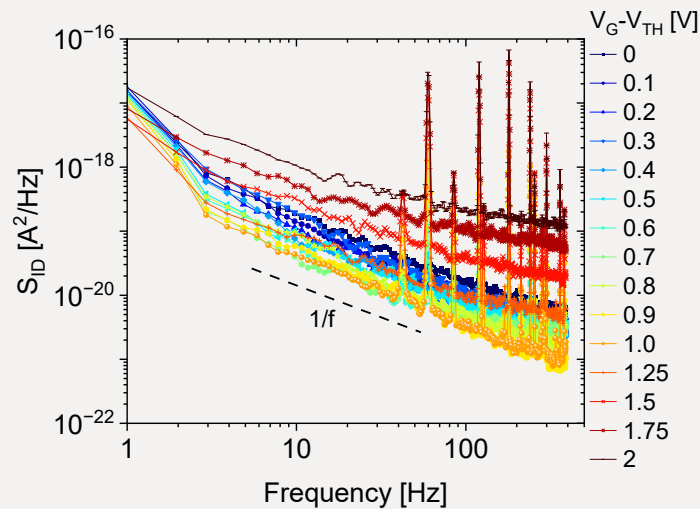
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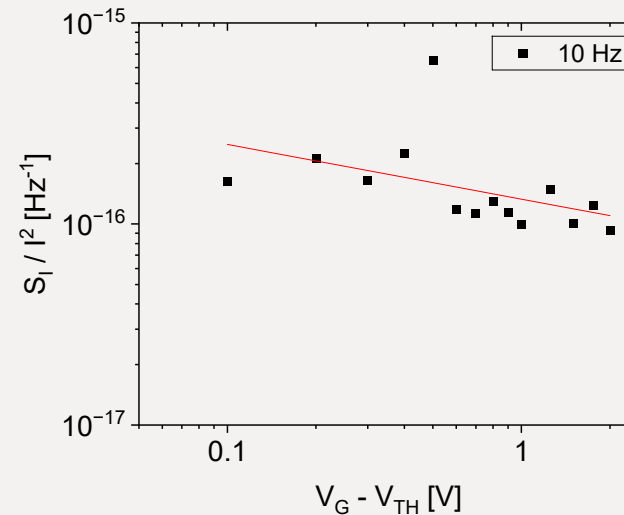
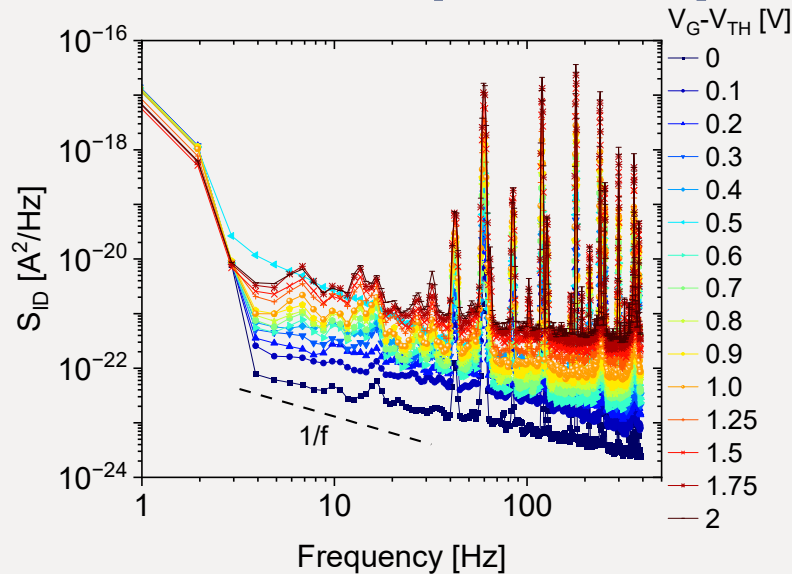
# Low frequency 1/f noise - MESFETs



- Noise trend shifts as device switches from linear to saturation
- Linear region shows  $1/V_G^3$  trend
  - Noise originating from the gated portion of channel
- Noise profile indicates a broad distribution of traps (corroborated by ac-gm)

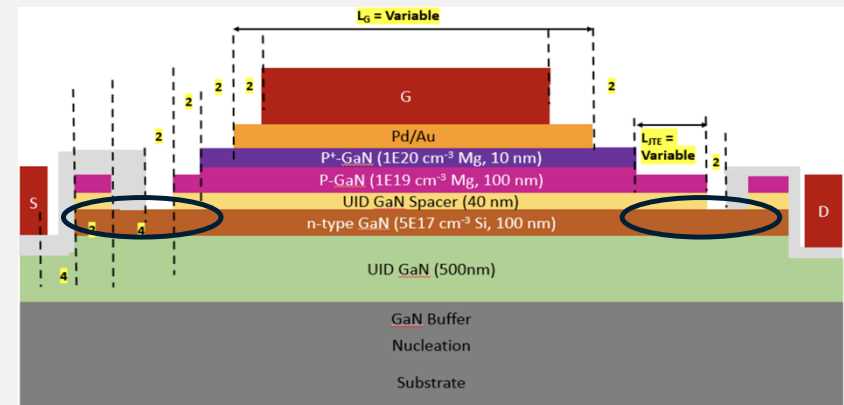
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# Low frequency 1/f noise - JFETs



- No clear correlation with  $V_G$
- Noise scales linearly with current
- Measured noise mainly stems from ungated region of channel

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# Year 2 accomplishments

- ✓ Developed a new model for AC transconductance method on
  - GaN MESFET
  - GaN JFET
- ✓ Pre-rad and post-rad characterization of GaN MESFET and JFET using
  - AC transconductance method
  - Low frequency  $1/f$  noise

# What next?

- Refine AC transconductance model
  - What is the mechanism of carrier trapping-detrapping
    - Tunneling? Others?
- Correlate AC transconductance with conductance method for MESFET and JFET
  - Conductance method model needs to be re-defined
- Further measurements on JFETs and MESFETs under irradiation
- Measurements on HEMTs before and after radiation

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